

S/N 10/808,192

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Daewoong Suh	Examiner:	Jonathan Johnson
Serial No.:	10/808,192	Group Art Unit:	1725
Filed:	March 24, 2004	Docket:	884.C25US1
Title:	SOLDERING AN ELECTRONICS PACKAGE TO A MOTHERBOARD		

**NOTICE OF APPEAL FROM THE DECISION OF THE EXAMINER
TO THE BOARD OF PATENT APPEALS AND INTERFERENCES**

MAIL STOP AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In compliance with 37 C.F.R. § 41.31(a)(1), Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision dated April 18, 2007 of the Examiner rejecting claims 1-7 and 9 of the above-identified patent application.

No extension of time is necessary to respond to the Examiner's rejection.

Please charge the amount of \$500.00 in payment of the Notice of Appeal fee under 37 C.F.R. § 41.20(b)(1), as well as any additional required fees, to Deposit Account No. 19-0743.

A Pre-Appeal Brief Request for Review is submitted herewith.

Respectfully submitted,

DAEWOONG SUH

By his Attorneys,

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